


**OSG60R099PEZF**   
Enhancement Mode N-Channel Power MOSFET

**Absolute Maximum Ratings** at  $T_j=25$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	600	V
Gate-source voltage	$V_{GS}$	$\pm 30$	V
Continuous drain current <sup>1)</sup> , $T_C=25$ °C	$I_D$	36	A
Continuous drain current <sup>1)</sup> , $T_C=100$ °C		22.8	
Pulsed drain current <sup>2)</sup> , $T_C=25$ °C	$I_{D, pulse}$	108	A
Continuous diode forward current <sup>1)</sup> , $T_C=25$ °C	$I_S$	36	A
Diode pulsed current <sup>2)</sup> , $T_C=25$ °C	$I_{S, pulse}$	108	

### Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		3231		pF	$V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , Hz
Output capacitance	$C_{oss}$		223.8		pF	
Reverse transfer capacitance	$C_{rss}$		2.2		pF	
Turn-on delay time	$t_{d(on)}$		40.2		ns	$V_{GS}=10\text{ V}$ , $V_{DS}=400\text{ V}$ , $R_G=2.5$ $I_D=16\text{ A}$
Rise time	$t_r$		29.4		ns	
Turn-off delay time	$t_{d(off)}$		87.2		ns	
Fall time	$t_f$		8.4		ns	

### Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	$Q_g$		57.8		nC	$V_{GS}=10\text{ V}$ , $V_{DS}=400\text{ V}$ , $I_D=16\text{ A}$
Gate-source charge	$Q_{gs}$		17.2		nC	
Gate-drain charge	$Q_{gd}$		18.8		nC	
Gate plateau voltage	$V_{plateau}$		5.9		V	

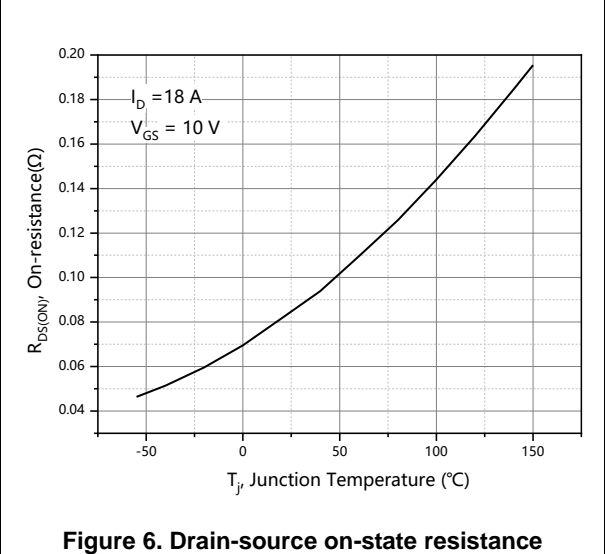
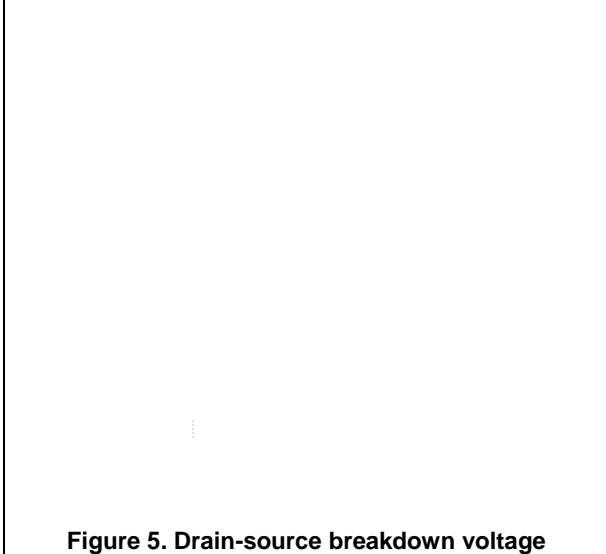
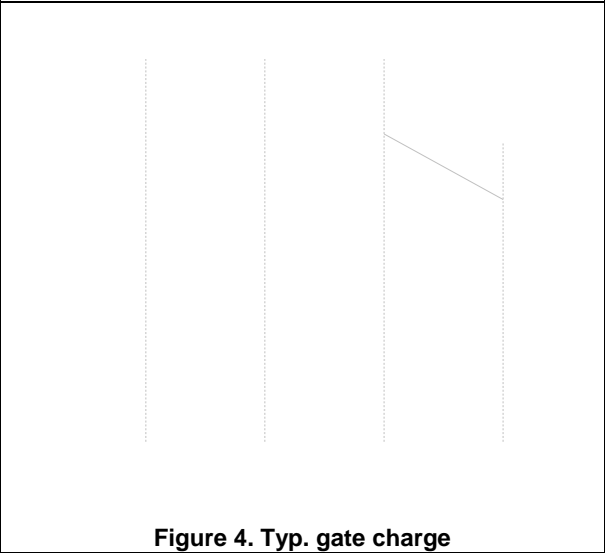
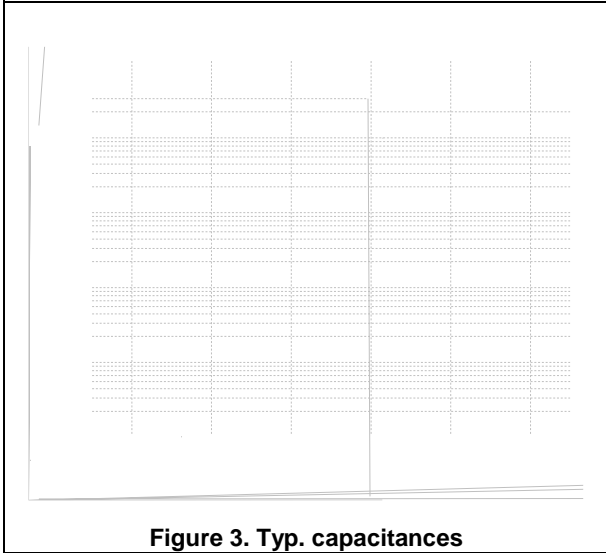
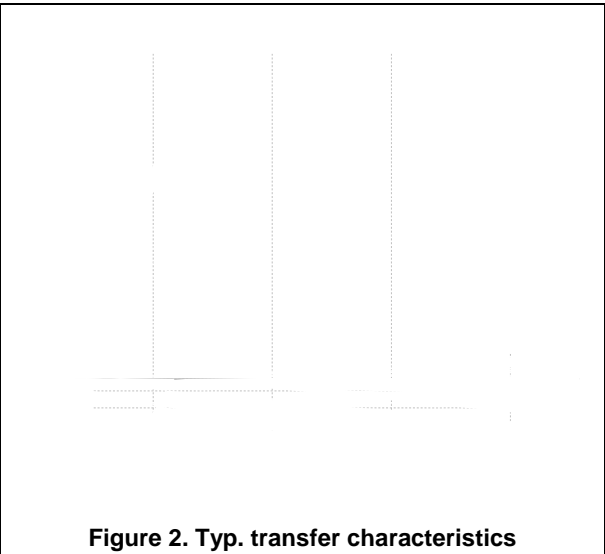
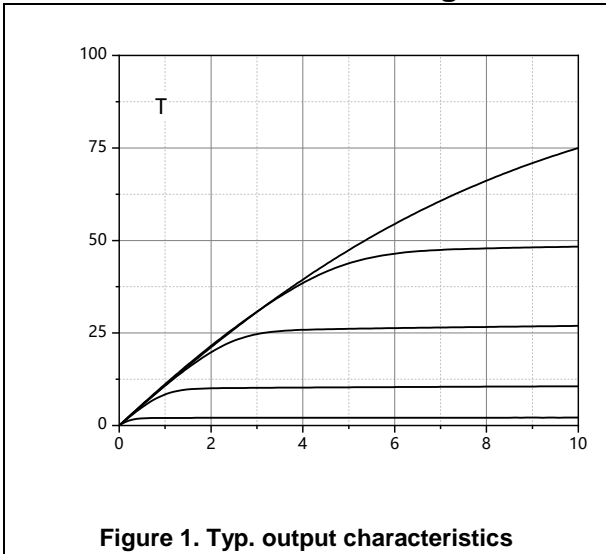
### Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	$V_{SD}$			1.4	V	$I_S=36\text{ A}$ , $V_{GS}=0\text{ V}$
Reverse recovery time	$t_{rr}$		138		ns	$I_S=16\text{ A}$ ,
Reverse recovery charge	$Q_{rr}$		756		nC	
Peak reverse recovery current	$I_{rrm}$		10.1		A	

### Note

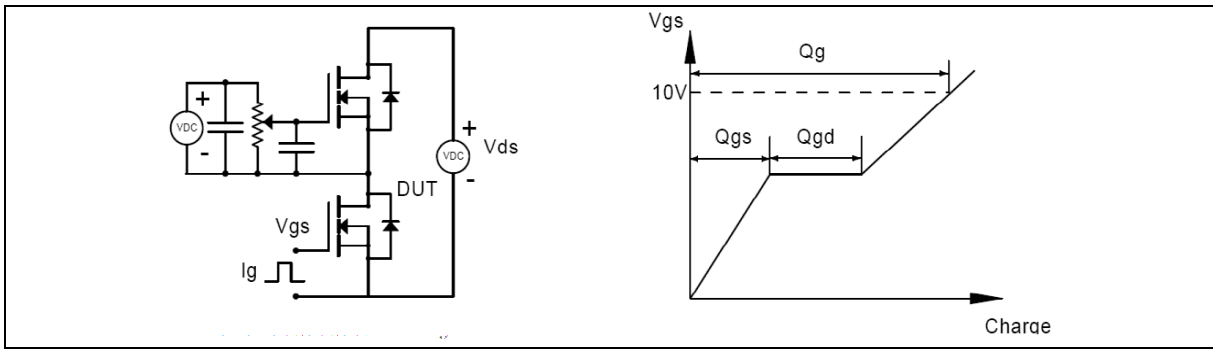
- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ °C}$ .
- 5)  $V_{DD}=100\text{ V}$ ,  $V_{GS}=10\text{ V}$ ,  $L=80\text{ mH}$ , starting  $T_j=25\text{ °C}$ .

**Electrical Characteristics Diagrams**





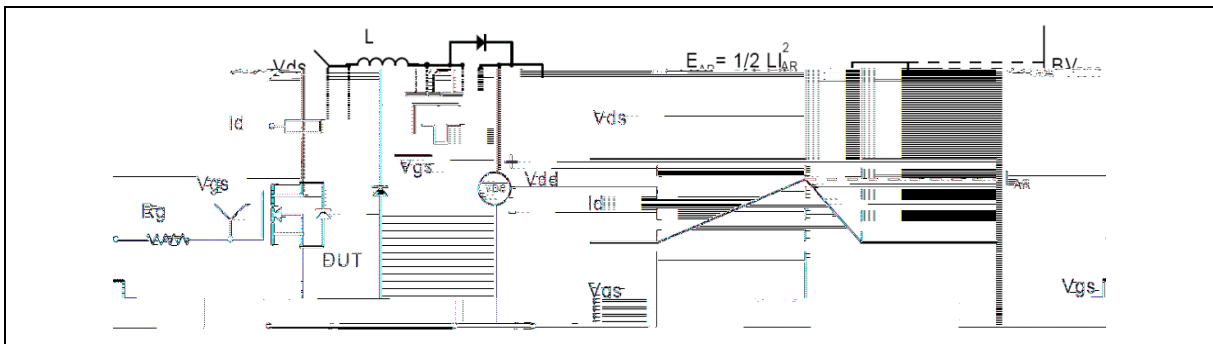
**Test circuits and waveforms**



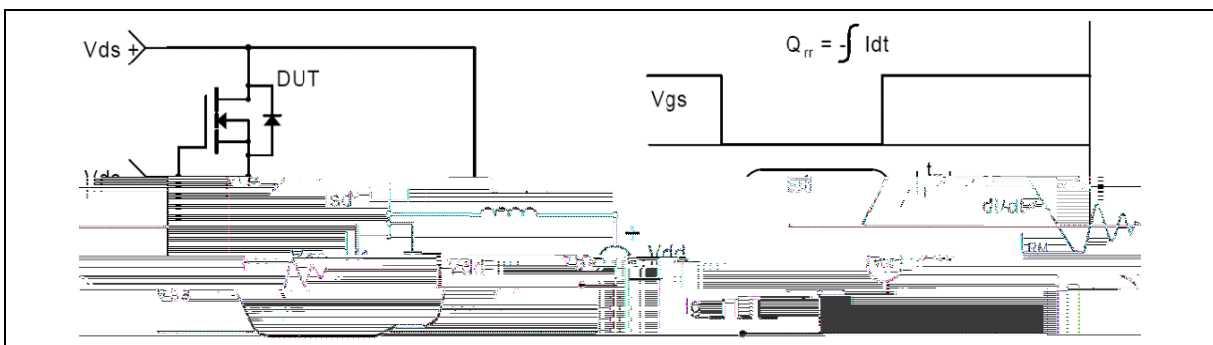
**Figure 1. Gate charge test circuit & waveform**



**Figure 2. Switching time test circuit & waveforms**



**Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms**



**Figure 4. Diode reverse recovery test circuit & waveforms**



**Ordering Information**

Package Type	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO220-J	50	20	1000	5	5000

**Product Information**

Product	Package	Pb Free	RoHS	Halogen Free
OSG60R099PEZF	TO220	yes	yes	yes